PCN Number:	202				PCI	N Da	te:	January 12, 2023
Title: Qualification of new Fab site (RFAB) using qualified Process Datasheet update and additional Assembly site/BOM option								•
Customer Contact:		PCN	<u>Manager</u>		Dep	ot:		Quality Services
Proposed 1 st Ship Date:							iests intil:	February 12, 2023*
*Sample requests received after February 12, 2023 will not be supported.							rted.	
Change Type:								
			Assembly Process			\boxtimes	Asser	mbly Materials
☑ Design			Electrical Specificat	ion		Mech		anical Specification
☐ Test Site			Packing/Shipping/L	abeling		Test		Process
☐ Wafer Bump Site	☐ Wafer Bump Site		Wafer Bump Material				Wafer Bump Process	
₩afer Fab Site			☑ Wafer Fab Materials			\boxtimes	Wafer Fab Process	
			Part number chang	е			•	
PCN Details								

Description of Change:

Texas Instruments is pleased to announce the qualification of a new fab & process technology (RFAB, LBC9) and assembly (MLA) site/BOM options for selected devices as listed below in the product affected section.

	Current Fab	Site	New Fab Site			
Fab Site	Process	Wafer Diameter	Fab Site	Process	Wafer Diameter	
SFAB	IMP-PWR2	150 mm	RFAB	LBC9	300 mm	

The die was also changed as a result of the process change.

Construction Differences are as follows:

What	ASESH	MLA
Mold Compound	SID#EN2000763	4211880
Mount Compound	SID#EY1000063	4147858
Bond wire composition/diameter	Cu/1.0 mil	Cu/0.8 mil
Pin one symbolization	dot	dimple

The associated datasheet changes were notified in a separate Datasheet change notification on 11/18/2022 (Notification# 20221117000.0) as shown below:



UCC28C40, UCC28C41, UCC28C42, UCC28C43, UCC28C44, UCC28C45, UCC38C40, UCC38C41, UCC38C42, UCC38C43, UCC38C44, UCC38C45

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Changes from Revision G (January 2017) to Revision H (September 2022)	Page
Changed -40°C to 105°C to -40°C to 125°C, and 0°C to 70°C to 0°C to 85°C	1
Removed PDIP package from Device Information	1
Updated T _J range in Device Comparison Table	3
Removed PDIP package from Pin Configuration	
Removed PDIP package from Absolute Maximum Table	
Updated Total Power Dissipation values in Absolute Maximum Table	5
 Added V_{REF} maximum continuous voltage from external circuitry in Recommended Operating Co 	nditions5
Updated T ₁ max values in Recommended Operating Conditions Table	5
Updated all Thermal Resistance Numbers in Thermal Information	6
Updated Electrical Characteristics section	
Corrected a drawing error of OUT pin high-side FET connection	

These changes may be reviewed at: http://www.ti.com/product/UCC28C40

Tube versions of the devices are included in EOL notice PDN# 20230112005.3.

Qual details are provided in the Qual Data Section.

Reason for Change:

These changes are part of our multiyear plan to transition products from our 150-milimeter factories to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity.

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

Impact on Environmental Ratings:

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
☑ No Change	☑ No Change	☑ No Change	☑ No Change

Changes to product identification resulting from this PCN:

Fab Site Information:

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
SH-BIP-1	SHE	USA	Sherman
RFAB	RFB	USA	Richardson

Die Rev:

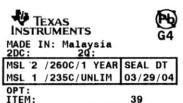
Current New

Die Rev [2P]	Die Rev [2P]
Α	A

Assembly Site Information:

Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (23L)	Assembly City
ASESH	ASH	CHN	Shanghai
MLA	MLA	MYS	Kuala Lumpur

Sample product shipping label (not actual product label):



(L)T0:1750

(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483812

(2P) REV: (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected:

UCC28C40DGKR	UCC28C42DGKR	UCC28C44DGKR	UCC38C43DGKR
UCC28C41DGKR	UCC28C43DGKR	UCC28C45DGKR	

For alternate parts with similar or improved performance, please visit the product page on TI.com

Qualification Report Approve Date 10-January-2023

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: UCC28C41DGKR	Qual Device: UCC28C43DGKR	Qual Device: UCC28C44DGKR	Qual Device: UCC28C44DGKR	QBS Reference: OPA2205ADGKR	QBS Reference: OPA2206ADGKR	QBS Reference: UCC28C44QDRQ1	QBS Reference: LM74700QDBVRQ1	QBS Reference: LM74700QDBVRQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	-	-	1/77/0	2/154/0	-	-	3/231/0
UHAST	А3	Autoclave	121C/15psig	96 Hours	-	-	1/77/0	-	-	-	-	-	3/231/0
UHAST	А3	Unbiased HAST	130C	96 Hours	-	-	-	-	1/77/0	2/154/0	-	-	-
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	1/77/0	-	1/77/0	2/154/0	-	-	2/154/0
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	-		1/77/0	2/154/0		-	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	-	-	-	-		-	-	1/45/0
HTOL	B1	Life Test	150C	300 Hours	-	-	-	-	1/77/0	2/154/0	-	-	-
HTOL	B1	Life Test	150C	408 Hours	-	-	-	-	-	-	-	1/77/0	2/154/0
ELFR	B2	Early Life Failure Rate	150C	24 Hours	-	-	-	-	1/800/0	2/2000/0	-	-	3/2400/0
ESD	E2	ESD CDM	-	250 Volts	-	-	1/3/0	-	1/3/0	2/6/0	1/3/0	1/3/0	-
ESD	E2	ESD HBM	-	1000 Volts	-	-	-	-	1/3/0	2/6/0	1/3/0	1/3/0	-
LU	E4	Latch-Up	Per JESD78	-	-	-	-	-	1/6/0	1/6/0	1/6/0	1/6/0	-
CHAR	E5	Electrical Characterization	Min, Typ, Max Temp	-	-	-	-	-	1/30/0	2/60/0	-	1/30/0	-

- . OBS: Qual By Similarit
- Qual Device UCC28C41DGKR is qualified at MSL2 260C
 Qual Device UCC28C43DGKR is qualified at MSL2 260C
 Qual Device UCC28C44DGKR is qualified at MSL2 260C
 Qual Device UCC28C44DGKR is qualified at MSL2 260C
 Qual Device UCC28C44DGKR is qualified at MSL2 260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7 eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
 The following are equivalent HTSL options based on an activation energy of 0.7 eV : 150C/1k Hours, and 170C/420 Hours
 The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	PCN ww admin team@list.ti.com

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